

**GaAs-IR-Lumineszenzdiode-Zeilen**  
**GaAs Infrared Emitter Arrays**  
**Lead (Pb) Free Product - RoHS Compliant**

**LD 260**  
**LD 262 ... LD 269**



**Wesentliche Merkmale**

- GaAs-IR-Lumineszenzdiode
- Zeilenbauform, lieferbar von 2 bis 10 Emittter pro Zeile
- Farbe: transparent
- Hohe Zuverlässigkeit
- Gruppiert lieferbar
- Gehäusegleich mit BPX 80-Serie
- Miniatur-Gehäuse

**Anwendungen**

- Miniaturlichtschranken für Gleich- und Wechsellichtbetrieb
- Barcodeleser
- Industrieelektronik
- „Messen/Steuern/Regeln“
- Sensorik
- Drehzahlsteuerung

**Features**

- GaAs infrared emitting diode
- Leadframe arrays, available from 2 to 10 Emitters per array
- Colour: transparent
- High reliability
- Available in bins
- Same package as BPX 80 series
- Miniature package

**Applications**

- Miniature photointerrupters
- Barcode readers
- Industrial electronics
- For control and drive circuits
- Sensor technology
- Speed controller

Typ Type	IRED pro Zeile per Row	Bestellnummer Ordering Code	Strahlstärkegruppierung <sup>1)</sup> ( $I_F = 50 \text{ mA}$ , $t_p = 20 \text{ ms}$ ) Radiant intensity grouping <sup>1)</sup> $I_e$ (mW/sr)
LD 262	2	Q62703Q0070	> 2.5 (typ. 5)
LD 263	3	Q62703Q0071	
LD 264	4	Q62703Q0072	
LD 265	5	Q62703Q0073	
LD 266	6	Q62703Q0074	
LD 267	7	Q62703Q0075	
LD 268	8	Q62703Q0076	
LD 269	9	Q62703Q0077	
LD 260	10	Q62703Q0078	

<sup>1)</sup> gemessen bei einem Raumwinkel  $\Omega = 0.01 \text{ sr}$  / measured at a solid angle of  $\Omega = 0.01 \text{ sr}$

**Grenzwerte ( $T_A = 25\text{ °C}$ )**  
**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Betriebs- und Lagertemperatur Operating and storage temperature range	$T_{op}; T_{stg}$	- 40 ... + 80	°C
Sperrschichttemperatur Junction temperature	$T_j$	80	°C
Sperrspannung Reverse voltage	$V_R$	5	V
Durchlassstrom Forward current	$I_F$	50	mA
Stoßstrom, $\tau \leq 10\ \mu\text{s}$ , $D = 0$ Surge current	$I_{FSM}$	1.6	A
Verlustleistung Power dissipation	$P_{tot}$	70	mW
Wärmewiderstand Thermal resistance	$R_{thJA}$ $R_{thJL}$	750 650	K/W K/W

**Kennwerte ( $T_A = 25\text{ °C}$ )**  
**Characteristics**

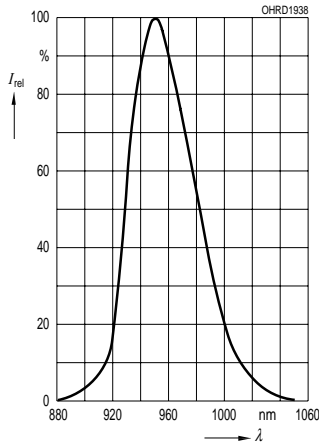
Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Wellenlänge der Strahlung Wavelength at peak emission $I_F = 50\text{ mA}$ , $t_p = 20\text{ ms}$	$\lambda_{peak}$	950	nm
Spektrale Bandbreite bei 50% von $I_{max}$ Spectral bandwidth at 50% of $I_{max}$ $I_F = 50\text{ mA}$ , $t_p = 20\text{ ms}$	$\Delta\lambda$	55	nm
Abstrahlwinkel Half angle	$\varphi$	$\pm 15$	Grad deg.
Aktive Chipfläche Active chip area	$A$	0.25	mm <sup>2</sup>
Abmessungen der aktiven Chipfläche Dimension of the active chip area	$L \times B$ $L \times W$	0.5 × 0.5	mm <sup>2</sup>
Abstand Chipoberfläche bis Linsenscheitel Distance chip surface to lens top	$H$	1.3 ... 1.9	mm

**Kennwerte** ( $T_A = 25\text{ °C}$ )  
**Characteristics** (cont'd)

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Schaltzeiten, $I_e$ von 10% auf 90% und von 90% auf 10%, bei $I_F = 50\text{ mA}$ , $R_L = 50\ \Omega$ Switching times, $I_e$ from 10% to 90% and from 90% to 10%, $I_F = 50\text{ mA}$ , $R_L = 50\ \Omega$	$t_r, t_f$	1	$\mu\text{s}$
Kapazität, $V_R = 0\text{ V}$ Capacitance	$C_o$	40	$\text{pF}$
Durchlassspannung, $I_F = 50\text{ mA}$ , $t_p = 20\ \mu\text{s}$ Forward voltage	$V_F$	1.25 ( $\leq 1.4$ )	$\text{V}$
Sperrstrom, $V_R = 5\text{ V}$ Reverse current	$I_R$	0.01 ( $\leq 1$ )	$\mu\text{A}$
Gesamtstrahlungsfluss, $I_F = 50\text{ mA}$ , $t_p = 20\text{ ms}$ Total radiant flux	$\Phi_e$	9	$\text{mW}$
Temperaturkoeffizient von $I_e$ bzw. $\Phi_e$ , $I_F = 50\text{ mA}$ Temperature coefficient of $I_e$ or $\Phi_e$ , $I_F = 50\text{ mA}$	$TC_I$	-0.55	$\%/K$
Temperaturkoeffizient von $V_F$ , $I_F = 50\text{ mA}$ Temperature coefficient of $V_F$ , $I_F = 50\text{ mA}$	$TC_V$	-1.5	$\text{mV}/K$
Temperaturkoeffizient von $\lambda_{\text{peak}}$ , $I_F = 50\text{ mA}$ Temperature coefficient of $\lambda_{\text{peak}}$ , $I_F = 50\text{ mA}$	$TC_\lambda$	0.3	$\text{nm}/K$
Strahlstärke, $I_F = 50\text{ mA}$ , $t_p = 20\text{ ms}$ Radiant intensity	$I_e$	typ. 5 ( $\geq 2$ )	$\text{mW}/\text{sr}$

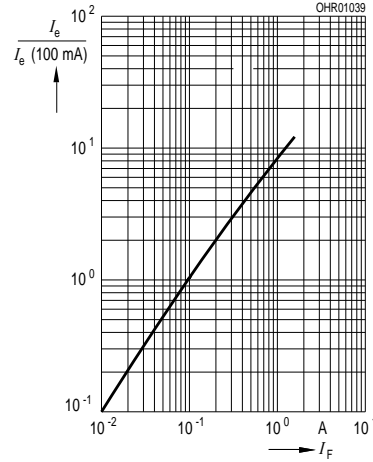
**Relative Spectral Emission**

$I_{rel} = f(\lambda)$



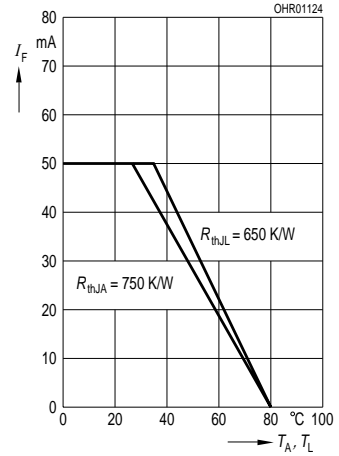
**Radiant Intensity**  $\frac{I_e}{I_e 100 \text{ mA}} = f(I_F)$

Single pulse,  $t_p = 20 \mu\text{s}$



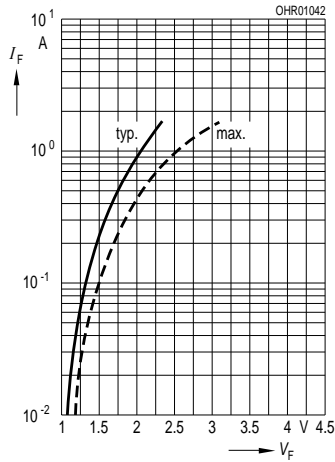
**Max. Permissible Forward Current**

$I_F = f(T_A)$



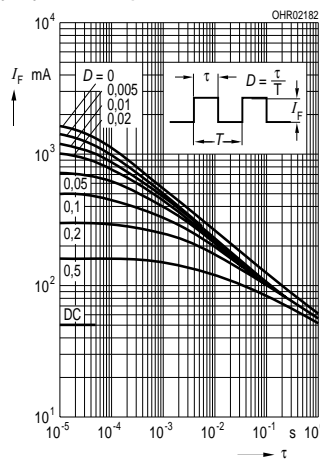
**Forward Current**

$I_F = f(V_F)$ , single pulse,  
 $t_p = 20 \mu\text{s}$

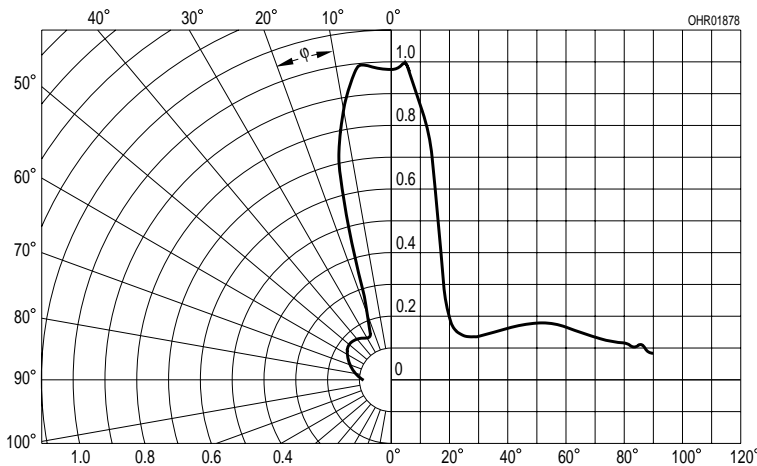


**Permissible Pulse Handling Capability**

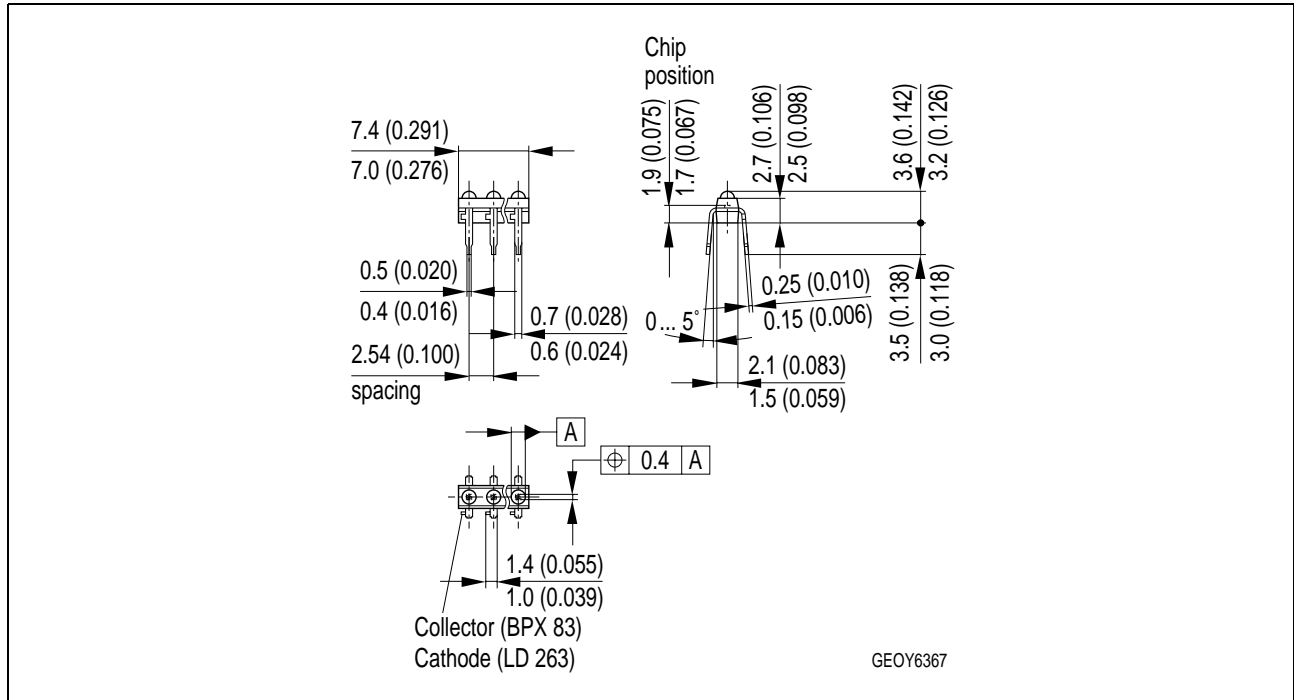
$I_F = f(\tau)$ ,  $T_C = 25 \text{ }^\circ\text{C}$ ,  
duty cycle  $D = \text{parameter}$



**Radiation Characteristics**  $I_{rel} = f(\varphi)$



## Maßzeichnung Package Outlines

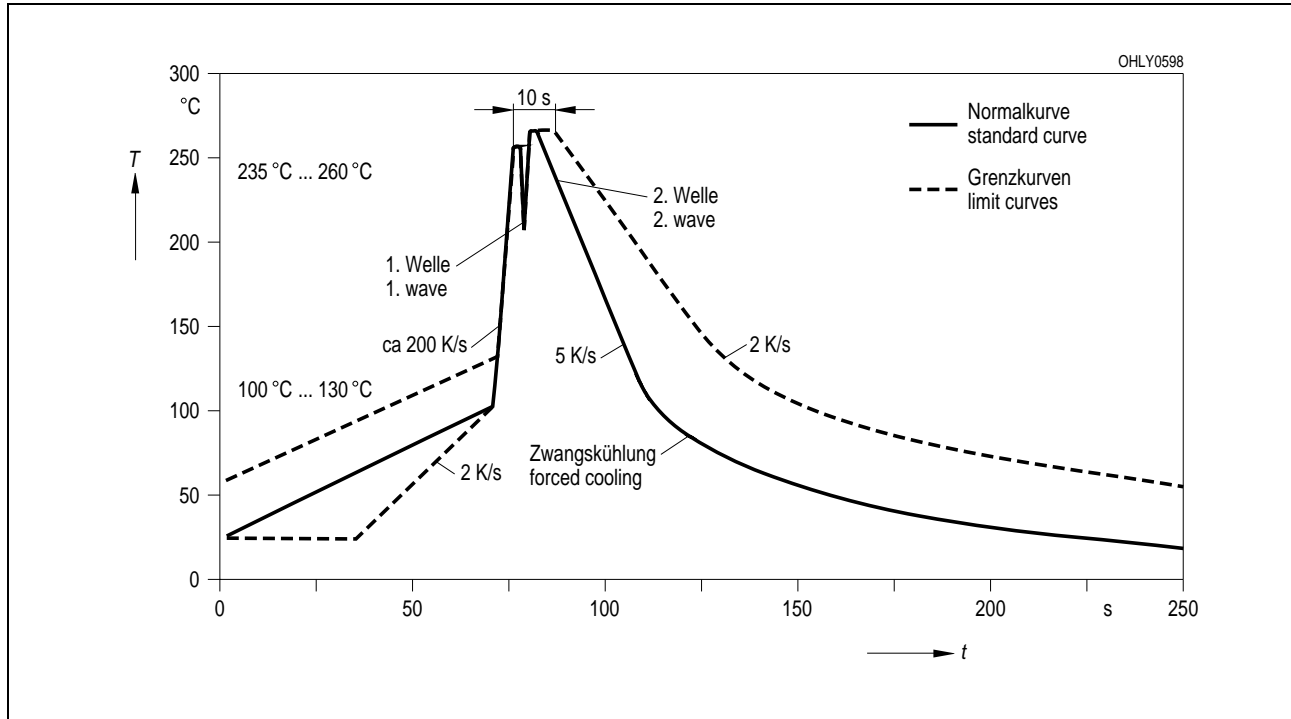


Maße in mm (inch) / Dimensions in mm (inch).

Typ	IRED pro Zeile	Maß „A“
Type	IRED per Row	Dimension „A“
LD 262	2	4.5 ... 4.9
LD 263	3	7.0 ... 7.4
LD 264	4	9.6 ... 10.0
LD 265	5	12.1 ... 12.5
LD 266	6	14.6 ... 16.0
LD 267	7	17.2 ... 17.6
LD 268	8	19.7 ... 20.1
LD 269	9	22.3 ... 22.7
LD 270	10	24.8 ... 25.2

**Lötbedingungen**  
**Soldering Conditions**  
**Wellenlöten (TTW)**  
**TTW Soldering**

(nach CECC 00802)  
(acc. to CECC 00802)



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Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

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<sup>1</sup> A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or effectiveness of that device or system.

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